



*Certification under 37 CFR 1.8(a)*

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with The United States Postal Service with sufficient postage as first class mail in an envelope addressed to THE COMMISSIONER FOR PATENTS, P.O. Box 1450, Alexandria, VA 22313-1450 on August 31, 2004.

Brian W. Hameder (Reg. No. 45,613)

Name

Signature

DOCKET: CU-3486

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Kyung Jun Kim

Serial No.: 10/733,650

Group Art Unit: 2825

Filed: December 11 2003

Examiner: Calvin Lee

For: METHOD FOR POLISHING COPPER LAYER AND METHOD FOR FORMING  
COPPER LAYER WIRING USING THE SAME

THE COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, VA 22313-1450

**TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT BEFORE MAILING OF A FINAL  
ACTION OR THE NOTICE OF ALLOWANCE**

The information disclosure statement submitted herewith is being filed before the mailing date of either a final action under §1.113, or a notice of allowance under §1.311 37 CFR 1.97(b), and is accompanied by a check for \$180.00 to cover the fee set forth in §1.17(p). The Commissioner is authorized to charge our Deposit Account No. 12-0400 for any required fees in excess of the amount submitted.

Date: August 31, 2004

Signature of Attorney

Brian W. Hameder

Ladas & Parry

224 South Michigan Avenue

Chicago Illinois 60604

Tel. No. (312) 427-1300

Reg. No. 45613

09/07/2004 BARBARA 00000027 10733650

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180.00-0P



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**INFORMATION DISCLOSURE STATEMENT**

Applicant submits herewith patents, publications or other information of which the applicant is aware, which may be material to the examination of this application and in respect of which there may be a duty to disclose under 37 CFR 1.56.

The filing of this information disclosure statement shall not be construed as a representation that a search has been made (37 CFR 1.97(g)), an admission that the information cited is, or is considered to be, material to patentability or that no other material information exists.

The filing of this information disclosure statement shall not be construed as an admission against interest in any manner. Notice of January 9, 1992, 1135 O.G. 13-25, at 25.

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180.00 DP

The references submitted herein are listed on PTO-1449 form (modified) enclosed herewith. A copy of each reference listed is being furnished except any duplicate or cumulative patents or publications specified otherwise. Also, if the present application was filed after June 30, 2003, copies of US patents or published applications are not submitted in accordance with the USPTO Rule changes.

A translation of any foreign language reference, if any, is indicated in PTO-1449 form and being submitted herein if it is readily available. Otherwise it should be construed that such translation is not readily available.

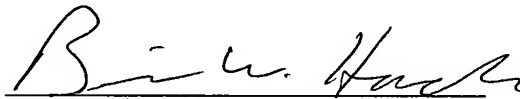
Additional comments, if any, on the relevance of each reference listed are provided as follows:

The Statement is made on the basis of the information:

_____	supplied by the inventor(s);
<u>  X  </u>	supplied by an individual associated with the filing and prosecution
_____	of this application (37 CFR 1.56(c)); or
_____	in the attorney's file.

Respectfully submitted,

Date: August 31, 2004



Signature of Attorney

Brian W. Hameder

Ladas & Parry

224 South Michigan Avenue

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FORM PTO-1449

(37 CFR 1.98(b))

ATTY. DOCKET NO.

CU-3486

SERIAL NO.
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10/733,650

**APPLICANT**

Kyung Jun Kim

FILING DATE

December 11, 2003

GROUP

2825

[illegible][illegible]

OTHER DOCUMENTS (including Author, Title, Date, Place of publication, etc.)			

EXAMINER

DATE CONSIDERED

**EXAMINER:** Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

(Form PTO-1449)